FORM PTO-1595 06-04			U.S. DEPARTMENT OF COM Patent and Trademar		
To the Director of the United States I	103318338	ri (#it i d# (ne attached original documents or	copy there	
1. Name of conveying party(ies):		2. Name a	and address of receiving party(ies):		
Shigeo TOOI, Tetsujiro TSUNODA Additional name(s) of conveying party(ie	s) attached? [] Ves • No		Mitsubishi Electric Corporation 7-3, Marunouchi 2-chome Chiyoda-ku, Tokyo 100-8310 Japan	J.S. PTO 3625	
3. Nature of Conveyance:	5) 100 100		· ·	48 √54	
Assignment	ger nge of Name			11294	
Execution Date: September 25, 2006		Additional name(s) and address(es) attached? Yes			
4. Application number(s) or patent number	er(s):				
This document is being filed together	r with a new application				
A. Patent Application No.(s)		B. Patent	No.(s)		
	Additional numbers attached	l? □ Ye	s No		
5. Name and address of party to whom co concerning document should be mailed:	rrespondence	6. Total a	pplications and patents involved: 1		
Customer Number 22850 Tcl. (703) 413-3000 Fax. (703) 413-2220		7. Total fee (37 CFR 3.41): \$40.00 Enclosed Authorized to be charged to deposit account 8. Deposit account number: 15-0030 (Attach duplicate copy of this page if paying by deposit account)			
	DO NOT USE TH	S SPACE	;		
9. Statement and signature To the best of my knowledge and belief, copy of the original document. Marvin J. Spivak Name of Person Signing	the foregoing information in Signat	14450		,	
Registration Number: 24,913	Registration i	lumber Jumber	- 1. 2. j. 7. l.		
Total	number of pages including	his cover	sheet: 2		
·	Do not detach this	portion			
Mail documents to be recorded with requi	red cover sheet information	to:			
	r of the United States Pate Mail Stop Assignment Rec Alexandria, Virgir	ordation S			

PATENT REEL: 018369 FRAME: 0781

5569200501 G979 US

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, t	he rec	eipt
and sufficiency of which is hereby acknowledged, the undersigned,		

(1) Shigeo TOOI

(2) Tetsujiro TSUNODA

who have made a certain new and useful invention, hereby sell, assign and transfer unto

Mitsubishi Electric Corporation 7.3, Marunouchi 2-chome Chiyoda-ku, Tokyo 100-8310 <u>JAPAN</u>

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

SEMICONDUCTOR DEVICE HAVING AN IMPROVED STRUCTURE FOR HIGH WITHSTAND VOLTAGE

for which an application for United States Letters Patent was executed on even date herewith,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the international Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

RECORDED: 10/02/2006

DATE SIGNED

September 25, 2006 September 25, 2006

PATENT REEL: 018369 FRAME: 0782